

PX1002

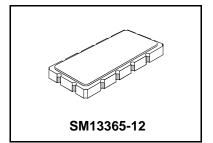
- Designed for TDMA IS-54 Receiver IF Applications
- **Low Insertion Loss**
- **Excellent Selectivity**
- Hermetic 13.3 X 6.5 mm Surface-Mount Case
- Unbalanced Input and Output
- Complies with Directive 2002/95/EC (RoHS)



Absolute Maximum Ratings

Rating	Value	Units
Maximum Incident Power in Passband	+10	dBm
Max. DC voltage between any 2 terminals	30	VDC
Storage Temperature Range	-40 to +85 °C	
Suitable for lead-free soldering - Max Soldering Profile	260°C for 30 s	

86.85 MHz **SAW Filter**



Electrical Characteristics

	Characteristic	Sym	Notes	Min	Тур	Max	Units
Nominal Center Frequency			1	86.850			MHz
Passband	Insertion Loss at fc	IL	'		3	4.0	dB
	3 dB Passband	BW ₃		±12	±25		kHz
	Amplitude Ripple over fc ±15 kHz		1.2			1.0	dB _{P-P}
	Group Delay Variation over fc ±10 kHz	GDV	1, 2			6.0	µs _{P-P}
Third-Order Intermod. for -20 dBm tones at fc ±60 & 120 kHz						-95	dBm
Rejection	fc ±60 kHz			11	16		
	fc -880 kHz to fc -940 kHz		1, 2, 3	65			dB
	Ultimate		1		65		,
Operating Temperatu	re Range	T _A	1	-20		+70	°C

Impedance Matching to 50 Ω unbalanced	External L-C		
Case Style	SM13365-12 13.3 X 6.5 mm Nominal Footprint		
Lid Symbolization (YY=year, WW=week) See note 4	RFM PX1002 YYWW		

Electrical Connections

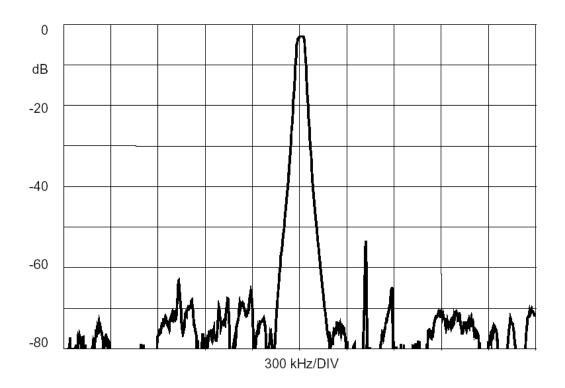
Connection	Terminals
Port 1Hot	2
Port 1 Gnd Return	3
Port 2 Hot	8
Port 2 Gnd Return	9
Case Ground	All Others

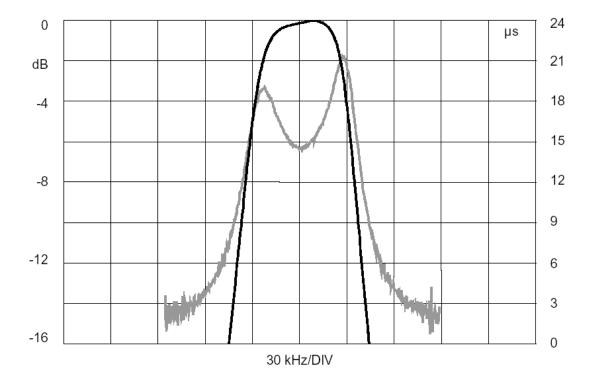
Notes:

- Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer.
- Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.
- Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
- "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
- The design, manufacturing process, and specifications of this filter are subject to change.
- Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit
- US and international patents may apply.
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- 10. Electrostatic Sensitive Device. Observe precautions for handling

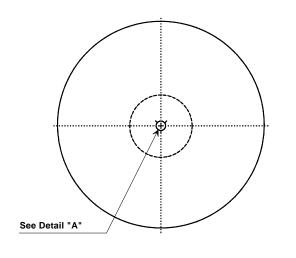


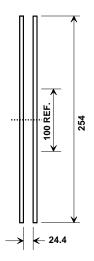
RF Monolithics, Inc. Phone: (972) 233-2903 Fax: (972) 387-8148 RFM Europe Phone: 44 1963 251383 Fax: 44 1963 251510 ©1999 by RF Monolithics, Inc. The stylized RFM logo are registered trademarks of RF Monolithics, Inc.



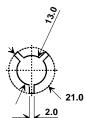


Tape and Reel Specifications

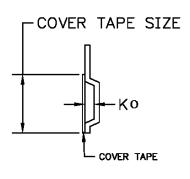




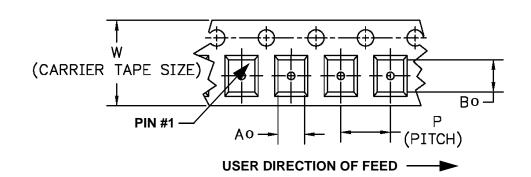
Quantity Per Reel
100 Min
1000 Max



COMPONENT ORIENTATION and DIMENSIONS

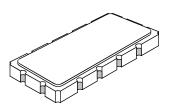


Carrier Tape Dimensions				
Ао	7.0 mm			
Во	13.8 mm			
Ко	2.0 mm			
Pitch	12.0 mm			
W	24.0 mm			



SM13365-12 Case

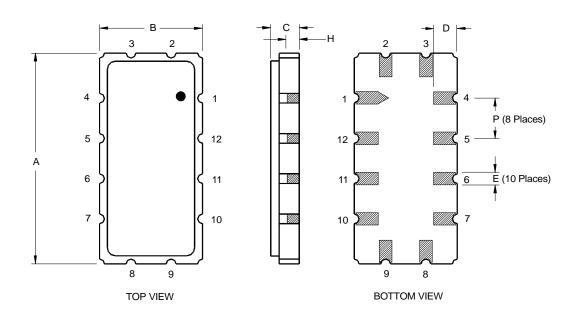
12-Terminal Ceramic Surface-Mount Case 13.3 x 6.5 mm Nominal Footprint



	Case Dimensions						
Dimension		mm			Inches		
Difficusion	Min	Nom	Max	Min	Nom	Max	
Α	13.08	13.31	13.60	0.515	0.524	0.535	
В	6.27	6.50	6.80	0.247	0.256	0.268	
С		1.91	2.00		0.075	0.079	
D		1.50			0.059		
E		0.79			0.031		
Н		1.0			0.039		
Р		2.54			0.100		

Materials					
Solder Pad Termination	Au plating 30 - 60 ulnches (76.2-152 uM) over 80- 200 ulnches (203-508 uM) Ni.				
Lid	Fe-Ni-Co Alloy Electroless Nickel Plate (8-11% Phosphorus) 100-200 ulnches Thick				
Body	Al ₂ O ₃ Ceramic				
Pb Free					

	Electrical Connections					
	Connection	Terminals				
Port 1	Input or Return	2				
	Return or Input	3				
Port 2	Output or Return	8				
	Return or Output	9				
	Ground	All others				
Single	Ended Operation	Return is ground				
Differe	ntial Operation	Return is hot				



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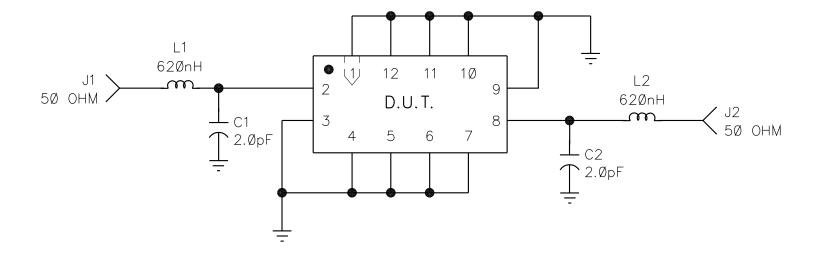
REV	ECN NO.	DESCRIPTION	DATE
Α	1192-21	INITIAL RELEASE	SB 5/20/94
В	4611	FIXTURE UPDATE	
С	1Ø225	REVISED PIN NUMBERING	Ø4octØ1

BILL OF MATERIALS

SEQ	QTY	RFM P/N	DESCRIPTION	REF DES	REFERENCE/ COMMENTS
1	1	400-0735-001	PCB (REV: X3)	PCB	
2	2	500-0003-020	CAP, NPO 2.0 pF	C1,2	±.25pF
3	2	N/A	CHIP INDUCTOR 620 nH	L1,2	±10%, Coilcraft#: 1008CS-621
4	2	500-0248-001	CONN, COAX, FLANGE MT. JACK	J1,2	
5	1	400-0533-001	SHIELD, BRASS	SHLD1	

DRAWN BY/DATE:	D. GAY	Ø4/26/94	TITLE: DEMO PCB, PX1ØØ2					
RF Monolith	, , , , , , , , , , , , , , , , , , ,	CHECKED/APPROVED	SIZE A	code ident 2U874	DWG. NO.	PX1ØØ2(DEMO)	REV C	1/6

SCHEMATIC, PX1002 (DEMO)



RF Monolithics, Inc.
DALLAS, TEXAS 75244

SIZE **A** CODE IDENT **2U874**

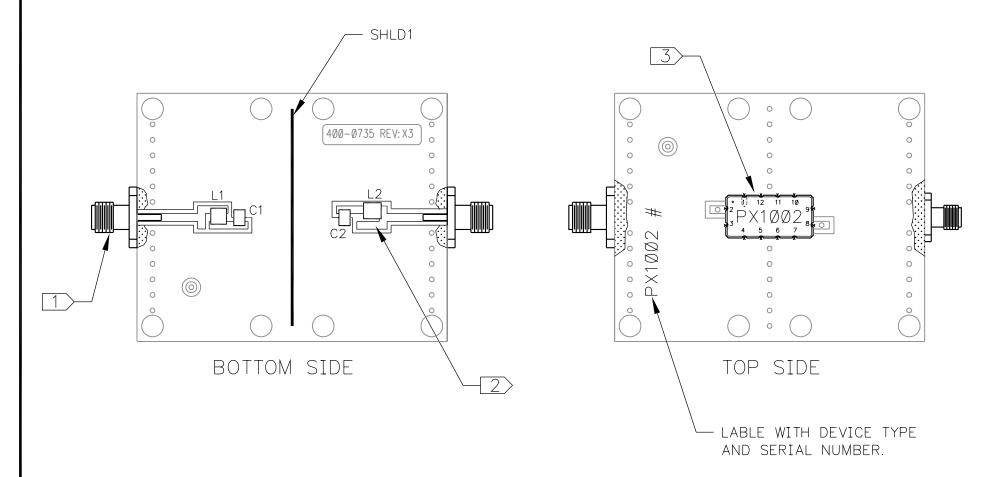
DWG. PX1ØØ2(DEMO)

REV

SHEET 2

NOTES:

- 1. SOLDER CONNECTORS, J1 & J2, TO PCB. SOLDER ON TOP AND BOTTOM SIDE OF PCB AS SHOWN.
- 2.>NOTE PROPER ORIENTATION OF INDUCTORS L1 AND L2.
 INDUCTORS SHOULD BE POSITIONED AT 90° TO EACH OTHER.
- 3. SOLDER SURFACE MOUNT PACKAGE, PX1002, TO TOP SIDE OF PCB. SOLDER AT 12 PLACES MARKED "X" AS SHOWN.



RF	Mond	olithi	cs,	Inc.
	DALLAS,	TEXAS	7524	4

SIZE

CODE IDENT 2U874

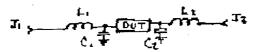
DWG. PX1ØØ2(DEMO)

REV C

SHEET 3

TUNING:

PLOT A SHOWS TYPICAL TUNING RESPONSE S21 AND SMITH CHART. PLOT B IS TO BE DELIVERED WITH EACH DEMO. THE TUNING COMPONENT VALUES MAY VARY IN ORDER TO ACHIEVE PROPER TUNING DUE TO COMPONENT TOLERANCES. NOTE COMPONENT VALUES AND TOLERANCES ON EACH PLOT.



PX1002, Plot A Ken C

